onsemi

MOSFET - Power, Single N-Channel 40 V, 2.5 mΩ, 130 A NVMFS5C442NL

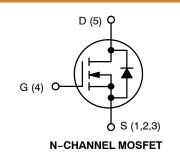
Features

- Small Footprint (5x6 mm) for Compact Design
- Low RDS(on) to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C442NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS	$(1) = 25^{\circ}$	J unless otherw	nse noted)			
Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	40	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain		$T_{C} = 25^{\circ}C$	۱ _D	130	А	
Current R _{θJC} (Notes 1, 3)	Steady	T _C = 100°C		95	1	
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	83	W	
$R_{\theta JC}$ (Note 1)		$T_{C} = 100^{\circ}C$		42		
Continuous Drain	Steady	T _A = 25°C	۱ _D	28	А	
Current R _{θJA} (Notes 1, 2, 3)		$T_A = 100^{\circ}C$		20	1	
Power Dissipation	State	T _A = 25°C	PD	3.7	W	
$R_{\theta JA}$ (Notes 1, 2)		T _A = 100°C		1.8		
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	900	А	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			۱ _S	81	А	
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 10 \text{ A}$)			E _{AS}	265	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	$2.5~\mathrm{m}\Omega$ @ 10 V	100 4
40 V	$3.7~\mathrm{m}\Omega$ @ $4.5~\mathrm{V}$	130 A

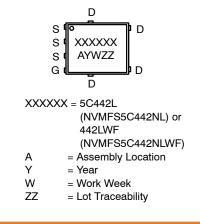




DFN5 (SO-8FL) CASE 488AA STYLE 1

(FULL-CUT SO8FL WF) CASE 507BA DFNW5

MARKING DIAGRAM



ORDERING INFORMATION

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.8	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	41	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

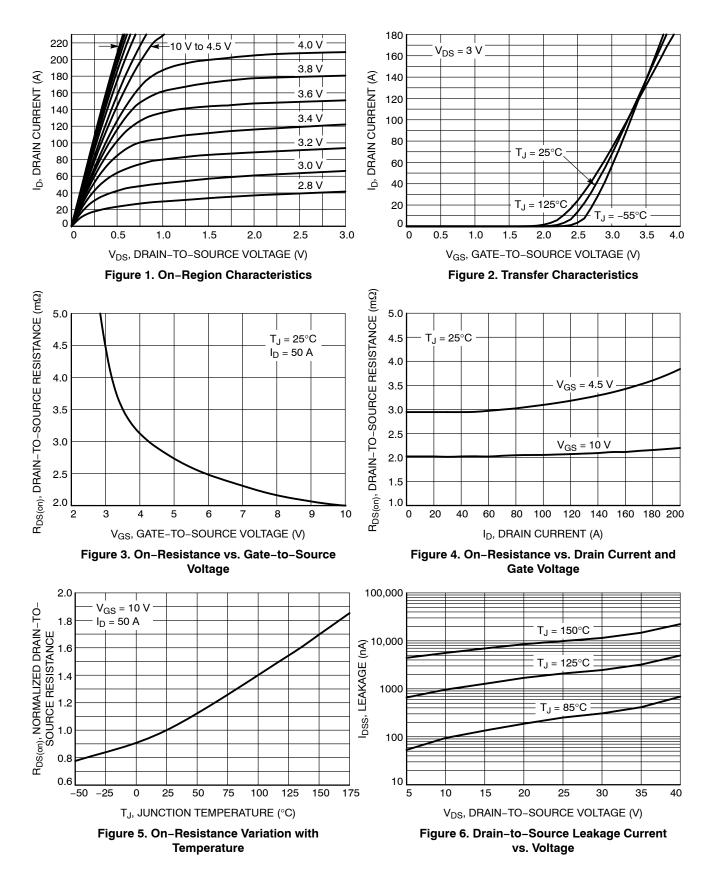
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle. See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

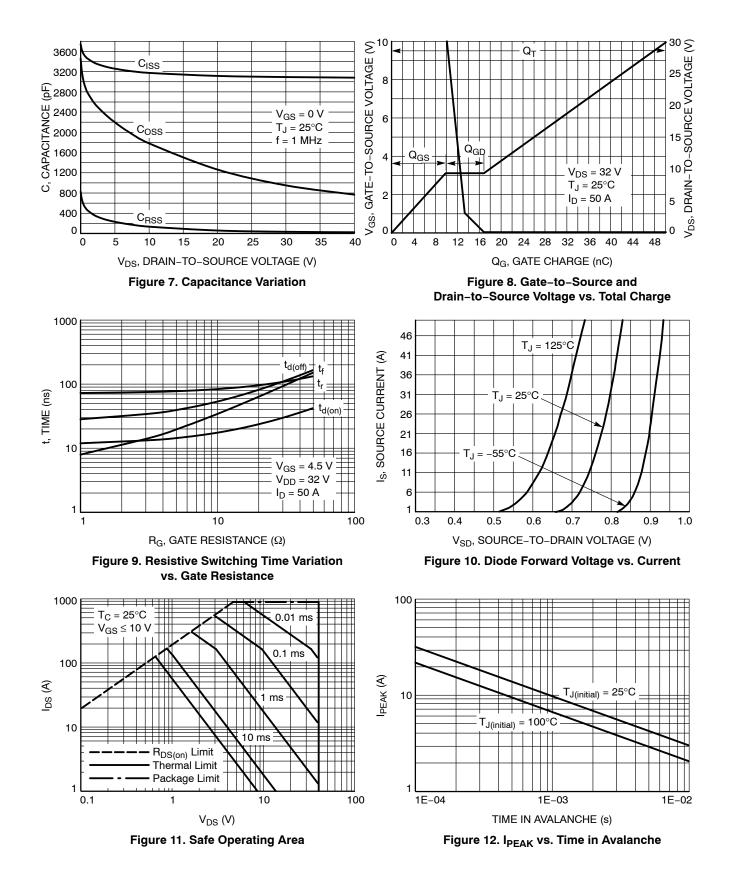
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				24.8		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	T _J = 25 °C			10	μΑ
		$V_{DS} = 40 V$	T _J = 125°C			250	
		V_{GS} = 0 V, V_{DS} = 20 V, T_{J} = 125°C				20	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)				-	-		-
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	= 90 μA	1.2		2.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.4		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	l _D = 50 A		2.0	2.5	mΩ
		V _{GS} = 4.5 V	l _D = 50 A		2.9	3.7	
Forward Transconductance	9 _{FS}	V _{DS} = 15 V, I _D = 50 A			116		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			3100		pF
Output Capacitance	C _{OSS}				1100		
Reverse Transfer Capacitance	C _{RSS}				37		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 32 V; I_{D} = 50 A			23		nC
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 32 V; I_{D} = 50 A			50		
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 32 V; I _D = 50 A			5.0		
Gate-to-Source Charge	Q _{GS}				9.8		1
Gate-to-Drain Charge	Q _{GD}				6.7		
Plateau Voltage	V _{GP}				3.1		V
SWITCHING CHARACTERISTICS (Note 5	5)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 32 V, I _D = 50 A, R _G = 1.0 Ω			12		ns
Rise Time	t _r				8.3		-
Turn–Off Delay Time	t _{d(OFF)}				28		
Fall Time	t _f				9.4		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V, I _S = 50 A	$T_J = 25^{\circ}C$		0.85	1.2	V
			T _J = 125°C		0.73		1
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 50 A		h	46		ns
Charge Time	t _a				23		
Discharge Time	t _b				23		1
Reverse Recovery Charge	Q _{RR}				40		nC

performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



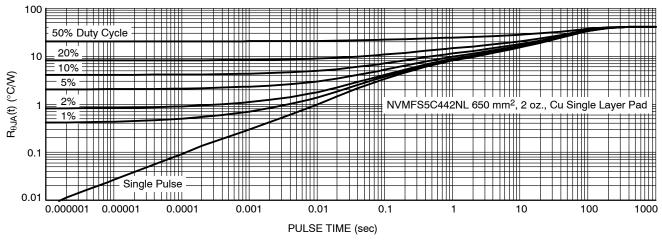


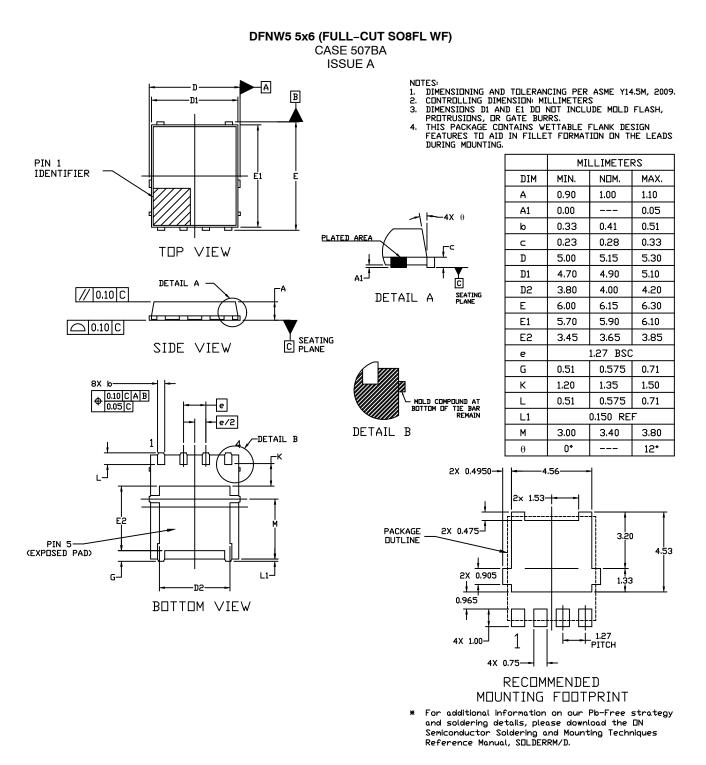
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5C442NLT1G	5C442L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C442NLWFT1G	442LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C442NLT3G	5C442L	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5C442NLWFT3G	442LWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C442NLAFT1G	5C442L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C442NLWFAFT1G	442LWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS







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